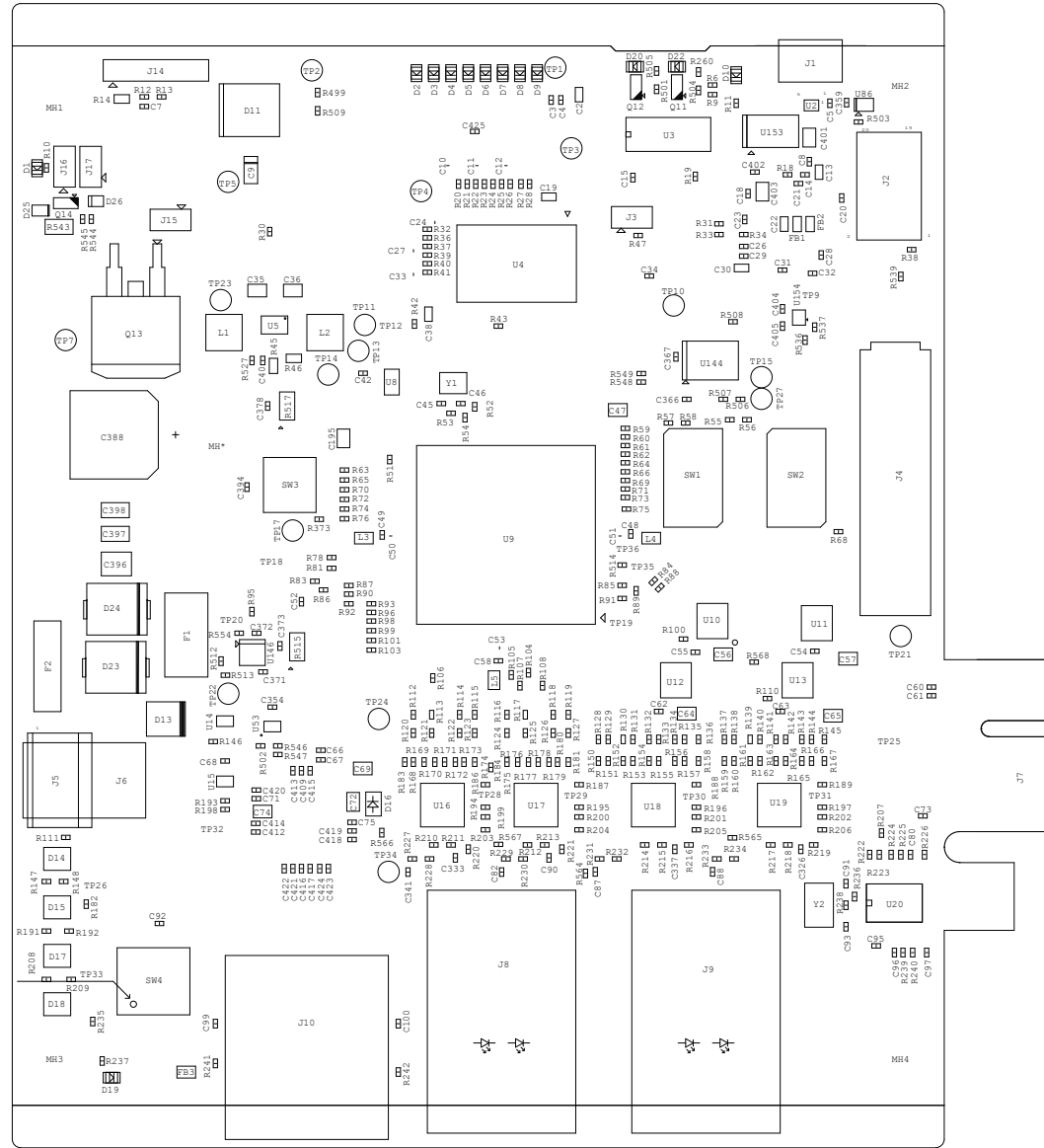
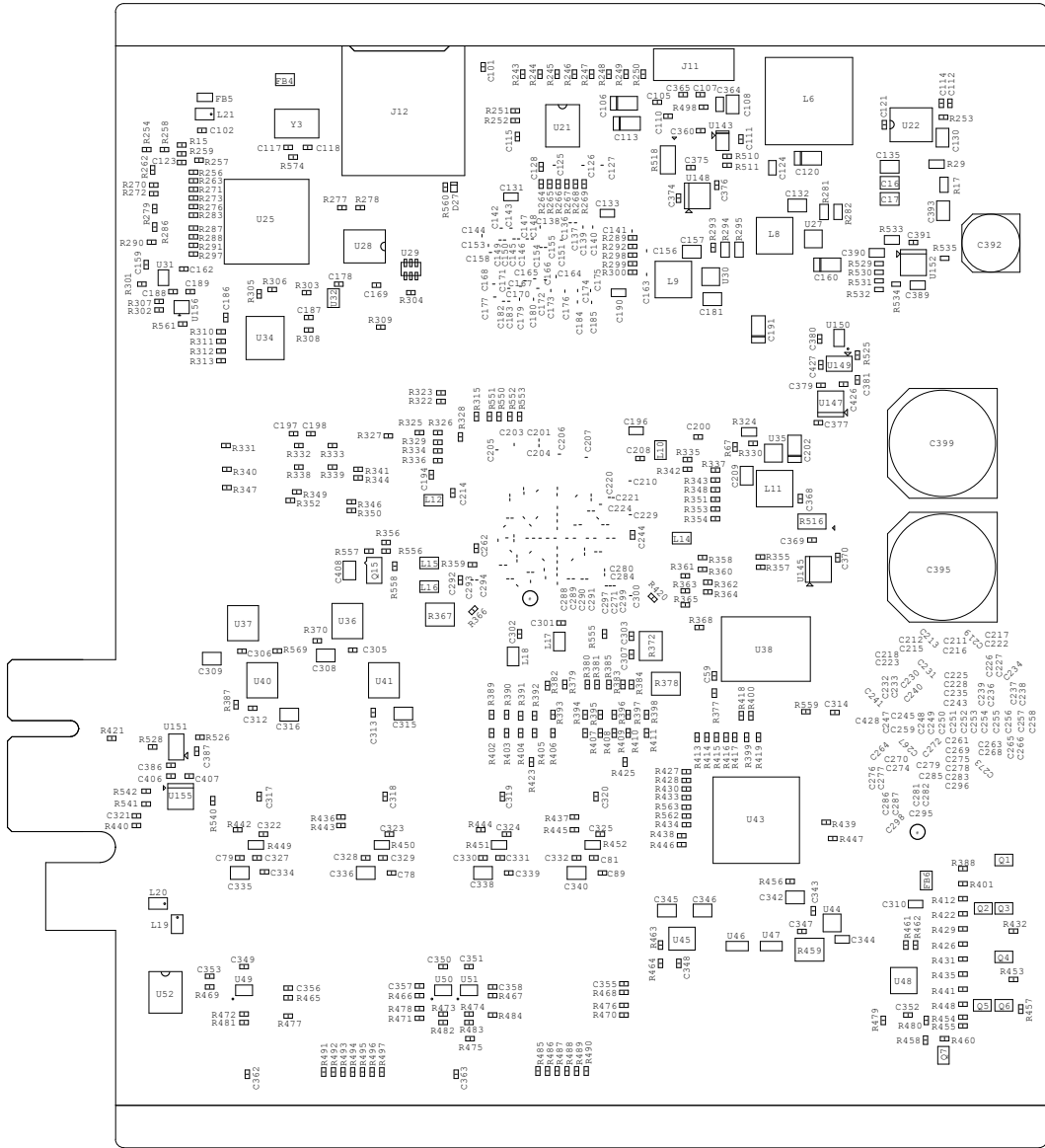


Note:
Assembly marking must match with marking in physical component (pin 4)
This marking does not refer pins





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